

NP60N055VUK

MOS FIELD EFFECT TRANSISTOR

R07DS0588EJ0100 Rev.1.00 Dec 12, 2011

Description

The NP60N055VUK is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

• Super low on-state resistance

 $R_{DS(on)} = 5.5 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_D = 30 \text{ A})$

- Low C_{iss} : $C_{iss} = 2500 \text{ pF TYP.} (V_{DS} = 25 \text{ V})$
- Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Pac	Package	
NP60N055VUK-E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	Taping (E1 type)	TO-252 (MP-3ZP)
NP60N055VUK-E2-AY *1			Taping (E2 type)	

Note: *1 Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	55	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25°C)	I _{D(DC)}	±60	A
Drain Current (pulse) *1	I _{D(pulse)}	±240	А
Total Power Dissipation (T _C = 25°C)	P _{T1}	105	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.2	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	-55 to 175	°C
Repetitive Avalanche Current *2	I _{AR}	25	A
Repetitive Avalanche Energy *2	E _{AR}	63	mJ

Notes: *1 T_C = 25°C, $P_W \le 10~\mu s$, Duty Cycle $\le 1\%$

Thermal Resistance

^{*2} R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

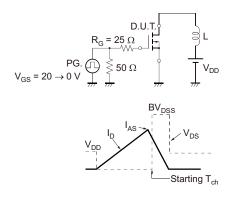
Electrical Characteristics $(T_A = 25^{\circ}C)$

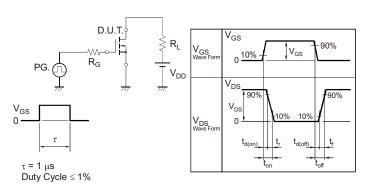
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{DS} = 55 V, V _{GS} = 0 V
Gate Leakage Current	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Forward Transfer Admittance *1	y _{fs}	22	44	_	S	$V_{DS} = 5 \text{ V}, I_{D} = 30 \text{ A}$
Drain to Source On-state Resistance *1	R _{DS(on)}	_	4.6	5.5	mΩ	V _{GS} = 10 V, I _D = 30 A
Input Capacitance	C _{iss}	_	2500	3750	pF	V _{DS} = 25 V
Output Capacitance	Coss	_	260	390	pF	$V_{GS} = 0 V$
Reverse Transfer Capacitance	C _{rss}	_	100	180	pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}	_	19	50	ns	V _{DD} = 28 V, I _D = 30 A
Rise Time	t _r	_	7	20	ns	V _{GS} = 10 V
Turn-off Delay Time	t _{d(off)}	_	45	90	ns	$R_G = 0 \Omega$
Fall Time	t _f	_	5	20	ns	
Total Gate Charge	Q_G	_	42	63	nC	V _{DD} = 44 V
Gate to Source Charge	Q _{GS}	_	11	_	nC	V _{GS} = 10 V
Gate to Drain Charge	Q_{GD}	_	10	_	nC	I _D = 60 A
Body Diode Forward Voltage *1	$V_{F(S-D)}$	_	0.9	1.5	V	I _F = 60 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}	_	44	_	ns	I _F = 60 A, V _{GS} = 0 V
Reverse Recovery Charge	Q _{rr}	_	45	_	nC	di/dt = 100 A/μs

Note: *1 Pulsed test

TEST CIRCUIT 1 AVALANCHE CAPABILITY

NCHE CAPABILITY TEST CIRCUIT 2 SWITCHING TIME

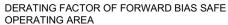


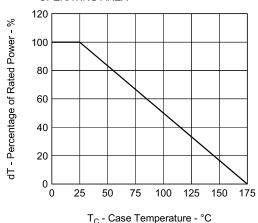


TEST CIRCUIT 3 GATE CHARGE

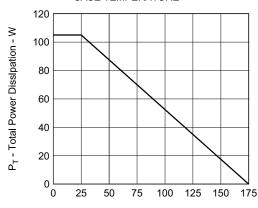
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Typical Characteristics $(T_A = 25^{\circ}C)$



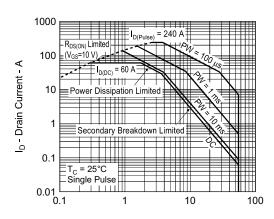


TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



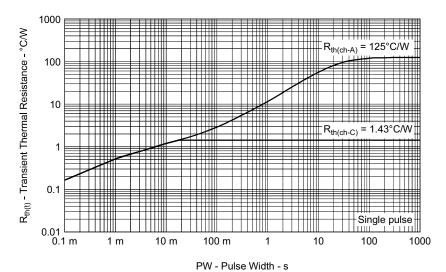
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA



V_{DS} - Drain to Source Voltage - V

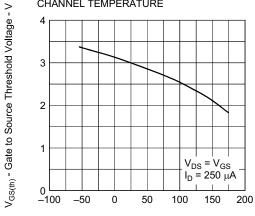
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE 300 250 I_D - Drain Current - A 200 150 100 50 V_{GS} = 10 Pulsed 0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 1.6 1.8

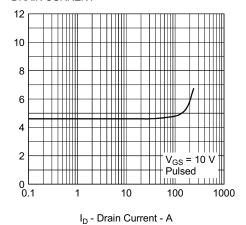
V_{DS} - Drain to Source Voltage - V



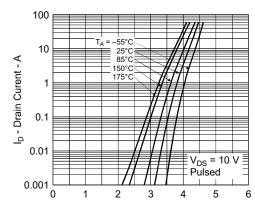


DRAIN TO SOURCE ON-STATE RESISTANCE vs. **DRAIN CURRENT**

 T_{ch} - Channel Temperature - $^{\circ}\text{C}$

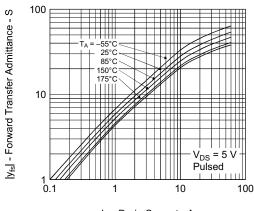


FORWARD TRANSFER CHARACTERISTICS



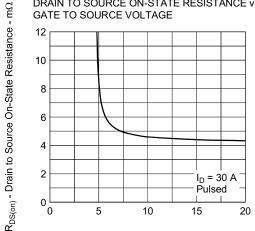
V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



I_D - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

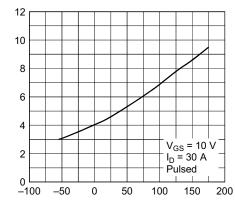


V_{GS} - Gate to Source Voltage - V

 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$

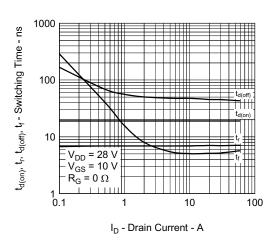
 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$



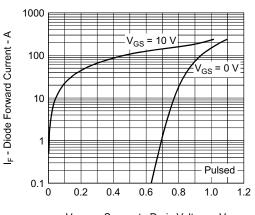


SWITCHING CHARACTERISTICS

T_{ch} - Channel Temperature - °C

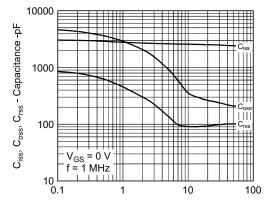


SOURCE TO DRAIN DIODE FORWARD VOLTAGE



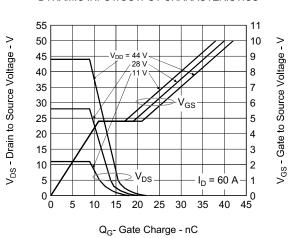
 $V_{F(S-D)}$ - Source to Drain Voltage - V

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

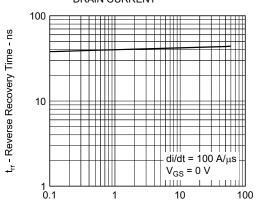


V_{DS} - Drain to Source Voltage - V

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



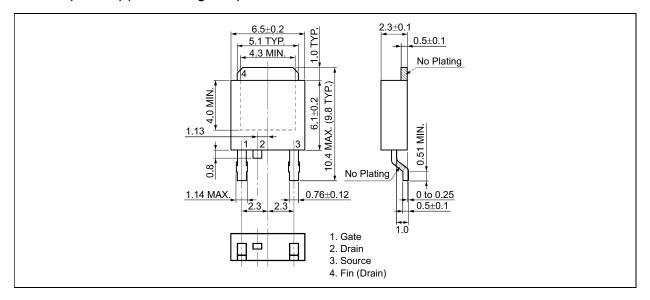
REVERSE RECOVERY TIME vs. DRAIN CURRENT



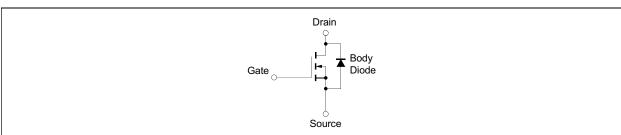
I_F - Drain Current - A

Package Drawing (Unit: mm)

TO-252 (MP-3ZP) (Mass: 0.27 g TYP.)



Equivalent Circuit



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

NP60N055VUK Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Dec 12, 2011	_	First Edition Issued	

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